Unit: mm

TOSHIBA Diode Silicon Epitaxial Planar Type

## **1SS387**

## **Ultra High Speed Switching Applications**

• Compact 2-pin package – ideal for high-density mounting

• Low forward voltage  $: V_{F(3)} = 0.98V \text{ (typ.)}$ • Fast reverse recovery time:  $t_{rr} = 1.6 \text{ns (typ.)}$ • Small total capacitance  $: C_{T} = 0.5 \text{pF (typ.)}$ 

### Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse voltage	$V_{RM}$	85	V
Reverse voltage	$V_{R}$	80	>
Maximum (peak) forward current	I <sub>FM</sub>	200	mA
Average forward current	Io	100	mA
Surge current (10ms)	I <sub>FSM</sub>	1	Α
Power dissipation	Р	150 *	mW
Junction temperature	Tj	125	°C
Storage temperature	T <sub>stg</sub>	<b>-</b> 55~125	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the

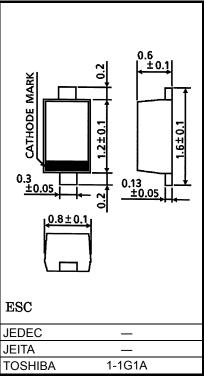
reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

\*: Mounted on a glass epoxy circuit board of 20 × 20mm, pad dimension of 4 × 4mm.

## **Electrical Characteristics (Ta = 25°C)**

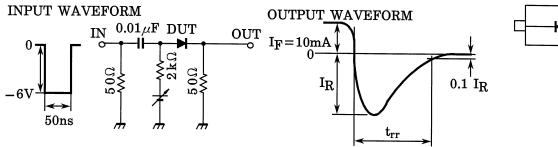
Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit	
Forward voltage	V <sub>F (1)</sub>	_	I <sub>F</sub> = 1mA	_	0.62	_		
	V <sub>F (2)</sub>	_	I <sub>F</sub> = 10mA	_	0.75	_	٧	
	V <sub>F (3)</sub>	_	I <sub>F</sub> = 100mA	_	0.98	1.20		
Reverse current	I <sub>R (1)</sub>	_	V <sub>R</sub> = 30V	_	_	0.1		
	I <sub>R (2)</sub>	_	V <sub>R</sub> = 80V	_	_	0.5	μA	
Total capacitance	C <sub>T</sub>	_	V <sub>R</sub> = 0, f = 1MH <sub>z</sub>	_	0.5	3.0	pF	
Reverse recovery time	t <sub>rr</sub>	_	I <sub>F</sub> = 10mA, Fig.1	_	1.6	4.0	ns	



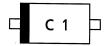
Weight: 1.4mg (typ)

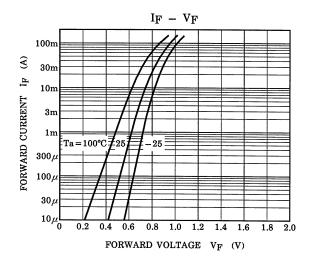
Fig.1 Reverse Recovery Time (t<sub>rr</sub>) Test Circuit

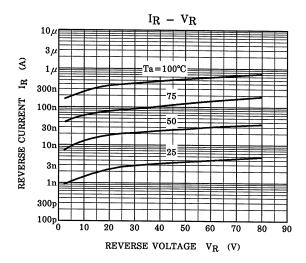
# Pin Assignment (Top View)

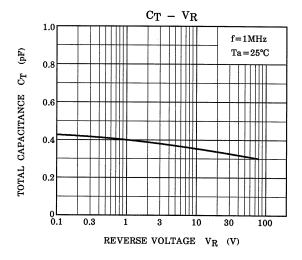


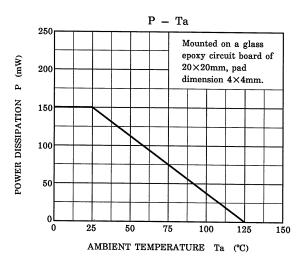
Marking











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